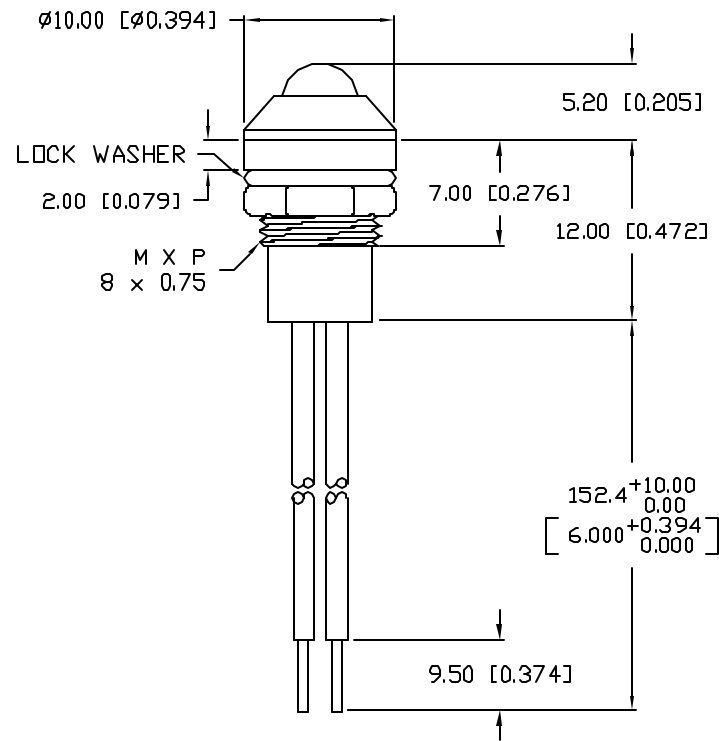
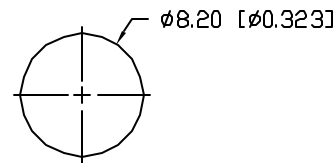


PANEL CUTOUT



NOTES:

1. SSL-LX5093SISUGW, BICOLOR RED/GREEN LED. TRIM TO 4mm.
2. SSI-LXR3816, CHROME HOUSING.
3. LXP-WA-3816, RUBBER GASKET.
4. SSH-LXH4815BSG, BUSHING, INSERT AND CRIMP.
5. RED ANODE LEAD: LXP-WST24RDTCC, 24 AWG. TINNED OVERCOAT, RED INSULATION, CUT 160mm LONG, STRIP 9.5mm & 3mm.
6. GREEN ANODE LEAD: LXP-WST24BLTCC, 24 AWG. TINNED OVERCOAT, BLACK INSULATION, CUT 160mm LONG, STRIP 9.5mm & 3mm.
7. ASSEMBLE IN ORDER: LED, SILICON, THEN BUSHING.
8. SPLASH RESISTANT PER NEMA SPEC. 250 SECTION 6.7.

ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		636 (RED)		nm	
		574 (GREEN)		nm	
FORWARD VOLTAGE (R/G)		2.0/2.2	2.5/2.6	V _f	
REVERSE VOLTAGE	5.0			V _r	I _r =100 μ A
AXIAL INTENSITY (R/G)		700/200		mcd	I _f =20mA
VIEWING ANGLE		60		2x theta	
EMITTED COLOR:		RED/GREEN			
EPOXY LENS FINISH:		MILKY WHITE DIFFUSED			

LIMITS OF SAFE OPERATION AT 25°C PER CHIP

PARAMETER	COLORS	MAX	UNITS
PEAK FORWARD CURRENT*		150	mA
STEADY CURRENT	(R/G)	30/25	mA
POWER DISSIPATION		105	mW
DERATE FROM 25°C		-1.2	mW/°C
OPERATING, STORAGE TEMP.		-40 TO +85	°C
SOLDERING TEMP.		+260	°C
2.0mm FROM BODY			3 SEC. MAX

* $t < 10\mu\text{s}$

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN.=^{+DECIMAL PRECISION}_{-0.00} MAX.=^{+0.00}_{-DECIMAL PRECISION}

REV.

PART NUMBER

SSI-LXR3816SIUGW6W

T-5mm RED/GREEN LED PANEL INDICATOR,
WHITE DIFFUSED LENS, 6.0" WIRE LEADS, SPLASH PROOF.

CONFIDENTIAL INFORMATION

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RELIABILITY NOTE

OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



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PAGE: 1 OF 1

SCALE: N/A